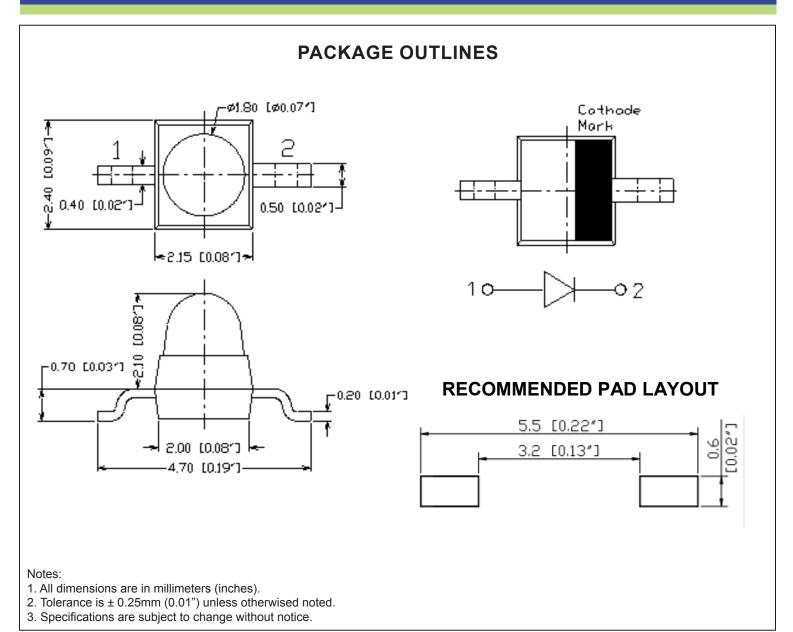


# SPECIFICATION CSM28R2CG



Part Number	Chip Material	Color of Emission Lens Type		Viewing Angle	
CSM28R2CG	InGaAIP	Red	Water Clear	20°	





## **ABSOLUTE MAXIMUM RATINGS**

(TA=25°C)

Parameter	Symbol	Max Rating	Unit	
Forward Current	lF	30	mA	
Reverse Current @ 5V	lR	10	μΑ	
Power Dissipation	Pd	75	mW	
Operating Temperature Range	Тор	-40~+80	°C	
Storage Temperature Range	Тѕтс	-40~+85	°C	
Peak Pulsing Current (1/10 duty f = 10KHz)	lFP	125	mA	
Soldering Temperature	TsoL	Max 260°C for 5 sec Max		

## **OPTICAL-ELECTRICAL CHARACTERISTICS**

(TA=25°C)

Darameter	Symbol	Test Condition	Value			l lait
Parameter			Min	Тур	Max	Unit
Luminous Intensity	lv	IF = 20mA	1600	2900	ı	mcd
Forward Voltage	VF	IF = 20mA	1	2.0	2.5	V
Reverse Leakage Current	lR	VR = 5V	-	-	10	μΑ
Viewing Angle at 50% Iv	201/2	IF = 10mA	ı	20	ı	Deg
Peak Wavelength	λР	IF = 20mA	1	630	-	nm
Dominant Wavelength	λD	IF = 20mA	620	625	630	nm

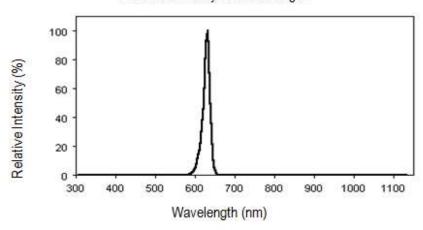
<sup>\*</sup>Tolerance of viewing angle: -10 / +5 deg.



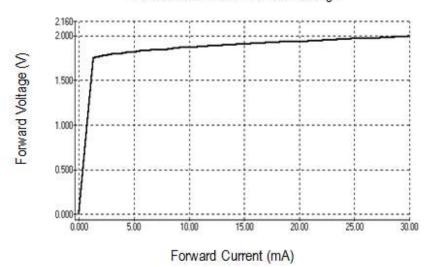


## **OPTICAL CHARACTERISTIC CURVES**

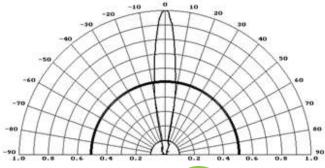
### Relative Intensity vs. Wavelength



## Forward Current vs. Forward Voltage



## Directive Characteristics

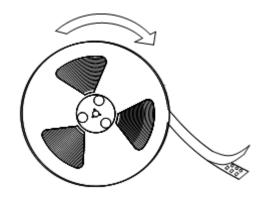


RoHS Compliant

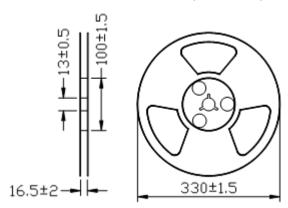


## **PACKAGING SPECIFICATION**

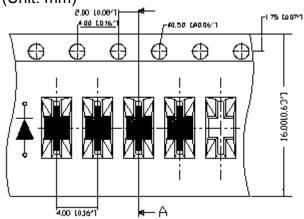
## **Feeding Direction**

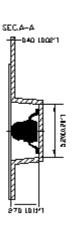


## Dimensions of Reel (Unit: mm)

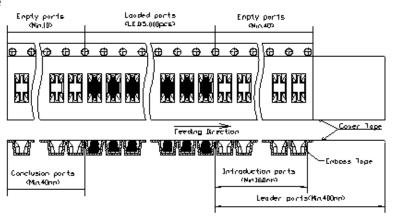


## Dimensions of Tape (Unit: mm)





### Arrangement of Tape



#### Notes:

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamp is two;
- 3. The cathode is oriented towards the tape sprocket hole;
- 4. 1,000 pcs/Reel

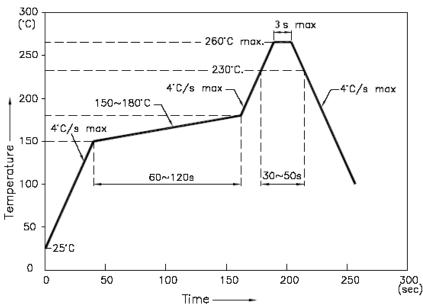




# **SOLDERING CONDITIONS**

## **REFLOW PROFILE**

### Reflow Temp/Time



#### Notes:

- 1. We recommend the reflow temperature 245°C (±5°C). The maximum soldering temperature should be limited to 260°C.
- 2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process should be 2 times or less.
- Soldering Iron

Basic spec is  $\leq 5$  sec when 260°C. If temperature is higher, time should be shorter ( $\pm 10^{\circ}\text{C} \rightarrow -1\text{sec}$ ). Power dissipation of iron should be smaller than 20W and temperature should be controllable. Surface temperature of the device should be under 230°C.